

swissbit®

Product Fact Sheet

Industrial
SD Memory Card

S-200 Series

SPI, SD compliant



S-200 SERIES

INDUSTRIAL SD MEMORY CARD – 512MB TO 2GB CLASS 6(10)

Main Feature

- Fully compliant with SD Memory Card specification 2.0
- SD and SPI Mode supported
- SDHC class 6 compliant
- High performance
 - SD burst up to 25MB/s
 - SD Low speed 0...25MHz clock rate
 - SD High speed 25...50MHz clock rate
 - Flash burst up to 40MB/s per channel
 - Up to 22MByte/sec sequential data rate
- Power Supply: (Low-power CMOS technology)
 - 2.7...3.6V normal operating voltage
 - 2.0...3.6V basic communication (CMD0, 15, 55 ACMD41) voltage
- Standard SD Memory Card form factor
 - 32.0mm x 24.0mm x 2.1mm
 - Write Protect slider
- Patented power-off reliability
 - No data loss of older sectors
 - Max. 16 sectors data loss (old data kept) if power off during writing
- Wear Leveling
Equal wear leveling of static and dynamic data. The wear leveling assures that dynamic data as well as static data is balanced evenly across the memory. With that the maximum write endurance of the device is guaranteed.
- Write Endurance
Due to intelligent wear leveling an even use of the entire flash is guaranteed, regardless how much "static" (OS) data is stored.
- High reliability
 - Best available SLC NAND Flash technology
 - Designed for embedded market
 - Number of card insertions/removals >10,000
 - Extended Temperature range -25° up to 85°C
 - Optional industrial Temperature range available -40° up to 85°C
- Controlled BOM & PCN process
- Life Time Monitoring SD/SPI with standard or vendor commands



System Performance

System Performance		typ	max	Unit
Burst Data transfer Rate (max clock 50MHz)			25	MB/s
Sustained Sequential Read	2GB	18.4	21	
Sustained Sequential Write	2GB	12.8	14	

Current Consumption @3.3V		typ	max	Unit
Write		55	60	mA
Read		28	40	
Sleep Mode		0.2	0.3	

Physical Dimensions

Physical Dimensions	value	Unit
Length	32.00±0.10	mm
Width	24.00±0.10	
Thickness	2.10±0.15	
Weight (typ.)	2	g

Recommended Temperature Conditions

Parameter	min	typ	max	Unit
Extended Operating Temperature	-25	25	85	°C
Industrial Operating Temperature	-40	25	85	°C
Storage Temperature	-40	25	100	°C

Humidity and ESD

Parameter	Operating	Non Operating
Humidity (non-condensing)	max 95%	
ESD according to IEC61000-4-2	Non Contact Pads area: ±8 kV (coupling plane discharge) ±15 kV (air discharge) Human body model according to IEC61000-4-2	Contact Pads: ±4 kV, Human body model according to IEC61000-4-2
Human body model		
±4 kV 100 pf/1.5 kOhm		
Machine model		
±0.25 kV 200 pf/0 Ohm		

Durability

Parameter	Operating	Non Operating
Salt water spray	3% NaCl/35°C; 24h acc. MIL STD Method 1009	
Solar Exposure / Impermeability	1000W/m2 @ 400°C / IP67	
UV Light Exposure	UV: 254nm, 15Ws/cm2	
Insertions / Drop test	>10,000/ 1.5m free fall	
Bending / Torque / Bump	10N / 0.15Nm or ±2.5deg / 25g; 6ms; ±3 x 4000 shocks	
Shock / Vibration (peak -to-peak)	1000 g max. / 15G max.	
Minimum moving force of WP slider	0.4N	

For more information on SD Memory Card Spec 2.0, please visit SD association (www.sdcard.org)

Why Swissbit?

Swissbit strives to create innovative technologies for future market opportunities utilizing a highly skilled in-house product research and development team. Swissbit maintains a marketing edge by continuing to manufacture world-class high quality memory products and providing customers with both high value and low cost of ownership achieved through efficient processes and procedures.